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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	768
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	111
Number of Gates	12000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 125°C (TA)
Package / Case	144-LBGA
Supplier Device Package	144-FPBGA (13x13)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microsemi/a54sx08a-fg144a">https://www.e-xfl.com/product-detail/microsemi/a54sx08a-fg144a</a>

## Logic Module Design

The SX-A family architecture is described as a “sea-of-modules” architecture because the entire floor of the device is covered with a grid of logic modules with virtually no chip area lost to interconnect elements or routing. The Actel SX-A family provides two types of logic modules: the register cell (R-cell) and the combinatorial cell (C-cell).

The R-cell contains a flip-flop featuring asynchronous clear, asynchronous preset, and clock enable, using the S0 and S1 lines control signals (Figure 1-2). The R-cell registers feature programmable clock polarity selectable on a register-by-register basis. This provides additional flexibility while allowing mapping of synthesized functions into the SX-A FPGA. The clock source for the R-cell can be chosen from either the hardwired clock, the routed clocks, or internal logic.

The C-cell implements a range of combinatorial functions of up to five inputs (Figure 1-3). Inclusion of the DB input and its associated inverter function allows up to 4,000

different combinatorial functions to be implemented in a single module. An example of the flexibility enabled by the inversion capability is the ability to integrate a 3-input exclusive-OR function into a single C-cell. This facilitates construction of 9-bit parity-tree functions with 1.9 ns propagation delays.

## Module Organization

All C-cell and R-cell logic modules are arranged into horizontal banks called Clusters. There are two types of Clusters: Type 1 contains two C-cells and one R-cell, while Type 2 contains one C-cell and two R-cells.

Clusters are grouped together into SuperClusters (Figure 1-4 on page 1-3). SuperCluster 1 is a two-wide grouping of Type 1 Clusters. SuperCluster 2 is a two-wide group containing one Type 1 Cluster and one Type 2 Cluster. SX-A devices feature more SuperCluster 1 modules than SuperCluster 2 modules because designers typically require significantly more combinatorial logic than flip-flops.

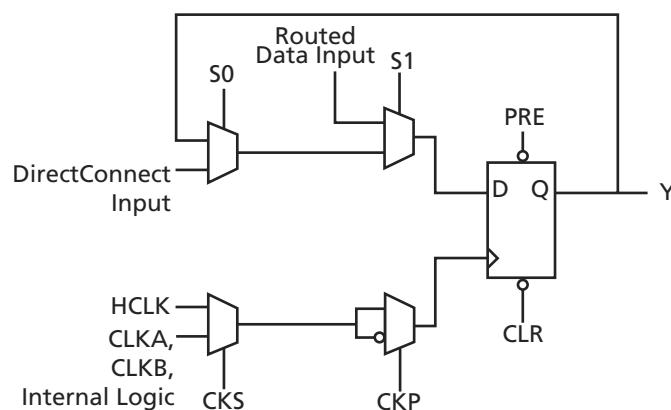


Figure 1-2 • R-Cell

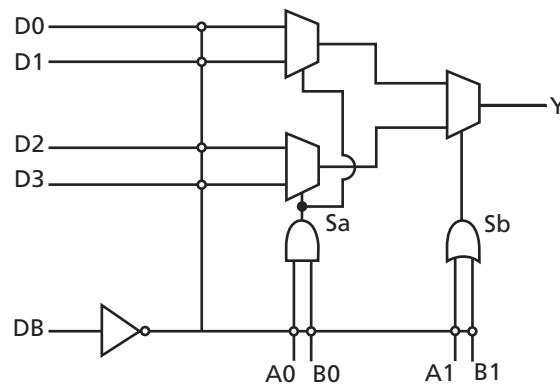


Figure 1-3 • C-Cell

## Power-Up/Down and Hot Swapping

SX-A I/Os are configured to be hot-swappable, with the exception of 3.3 V PCI. During power-up/down (or partial up/down), all I/Os are tristated.  $V_{CCA}$  and  $V_{CCI}$  do not have to be stable during power-up/down, and can be powered up/down in any order. When the SX-A device is plugged into an electrically active system, the device will not degrade the reliability of or cause damage to the host system. The device's output pins are driven to a high impedance state until normal chip operating conditions

are reached. Table 1-4 summarizes the  $V_{CCA}$  voltage at which the I/Os behave according to the user's design for an SX-A device at room temperature for various ramp-up rates. The data reported assumes a linear ramp-up profile to 2.5 V. For more information on power-up and hot-swapping, refer to the application note, *Actel SX-A and RT54SX-S Devices in Hot-Swap and Cold-Sparing Applications*.

Table 1-2 • I/O Features

Function	Description
Input Buffer Threshold Selections	<ul style="list-style-type: none"> <li>• 5 V: PCI, TTL</li> <li>• 3.3 V: PCI, LVTTL</li> <li>• 2.5 V: LVCMOS2 (commercial only)</li> </ul>
Flexible Output Driver	<ul style="list-style-type: none"> <li>• 5 V: PCI, TTL</li> <li>• 3.3 V: PCI, LVTTL</li> <li>• 2.5 V: LVCMOS2 (commercial only)</li> </ul>
Output Buffer	<p>"Hot-Swap" Capability (3.3 V PCI is not hot swappable)</p> <ul style="list-style-type: none"> <li>• I/O on an unpowered device does not sink current</li> <li>• Can be used for "cold-sparing"</li> </ul> <p>Selectable on an individual I/O basis</p> <p>Individually selectable slew rate; high slew or low slew (The default is high slew rate). The slew is only affected on the falling edge of an output. Rising edges of outputs are not affected.</p>
Power-Up	<p>Individually selectable pull-ups and pull-downs during power-up (default is to power-up in tristate)</p> <p>Enables deterministic power-up of device</p> <p><math>V_{CCA}</math> and <math>V_{CCI}</math> can be powered in any order</p>

Table 1-3 • I/O Characteristics for All I/O Configurations

	Hot Swappable	Slew Rate Control	Power-Up Resistor
TTL, LVTTL, LVCMOS2	Yes	Yes. Only affects falling edges of outputs	Pull-up or pull-down
3.3 V PCI	No	No. High slew rate only	Pull-up or pull-down
5 V PCI	Yes	No. High slew rate only	Pull-up or pull-down

Table 1-4 • Power-Up Time at which I/Os Become Active

Supply Ramp Rate	0.25 V/ $\mu$ s	0.025 V/ $\mu$ s	5 V/ms	2.5 V/ms	0.5 V/ms	0.25 V/ms	0.1 V/ms	0.025 V/ms
Units	$\mu$ s	$\mu$ s	ms	ms	ms	ms	ms	ms
A54SX08A	10	96	0.34	0.65	2.7	5.4	12.9	50.8
A54SX16A	10	100	0.36	0.62	2.5	4.7	11.0	41.6
A54SX32A	10	100	0.46	0.74	2.8	5.2	12.1	47.2
A54SX72A	10	100	0.41	0.67	2.6	5.0	12.1	47.2

## JTAG Instructions

Table 1-7 lists the supported instructions with the corresponding IR codes for SX-A devices.

Table 1-8 lists the codes returned after executing the IDCODE instruction for SX-A devices. Note that bit 0 is always '1'. Bits 11-1 are always '02F', which is the Actel manufacturer code.

Table 1-7 • JTAG Instruction Code

Instructions (IR4:IR0)	Binary Code
EXTEST	00000
SAMPLE/PRELOAD	00001
INTEST	00010
USERCODE	00011
IDCODE	00100
HighZ	01110
CLAMP	01111
Diagnostic	10000
BYPASS	11111
Reserved	All others

Table 1-8 • JTAG Instruction Code

Device	Process	Revision	Bits 31-28	Bits 27-12
A54SX08A	0.22 $\mu$	0	8, 9	40B4, 42B4
		1	A, B	40B4, 42B4
A54SX16A	0.22 $\mu$	0	9	40B8, 42B8
		1	B	40B8, 42B8
	0.25 $\mu$	1	B	22B8
A54SX32A	0.2 2 $\mu$	0	9	40BD, 42BD
		1	B	40BD, 42BD
	0.25 $\mu$	1	B	22BD
A54SX72A	0.22 $\mu$	0	9	40B2, 42B2
		1	B	40B2, 42B2
	0.25 $\mu$	1	B	22B2

## Probing Capabilities

SX-A devices also provide an internal probing capability that is accessed with the JTAG pins. The Silicon Explorer II diagnostic hardware is used to control the TDI, TCK, TMS, and TDO pins to select the desired nets for debugging. The user assigns the selected internal nets in Actel Silicon Explorer II software to the PRA/PRB output pins for observation. Silicon Explorer II automatically places the device into JTAG mode. However, probing functionality is only activated when the TRST pin is driven high or left floating, allowing the internal pull-up resistor to pull TRST High. If the TRST pin is held Low, the TAP controller remains in the Test-Logic-Reset state so no probing can be performed. However, the user must drive the TRST pin High or allow the internal pull-up resistor to pull TRST High.

When selecting the **Reserve Probe Pin** box as shown in Figure 1-12 on page 1-9, direct the layout tool to reserve the PRA and PRB pins as dedicated outputs for probing. This **Reserve** option is merely a guideline. If the designer assigns user I/Os to the PRA and PRB pins and selects the **Reserve Probe Pin** option, Designer Layout will override the **Reserve Probe Pin** option and place the user I/Os on those pins.

To allow probing capabilities, the security fuse must not be programmed. Programming the security fuse disables the JTAG and probe circuitry. Table 1-9 summarizes the possible device configurations for probing once the device leaves the Test-Logic-Reset JTAG state.

Table 1-9 • Device Configuration Options for Probe Capability (TRST Pin Reserved)

JTAG Mode	TRST <sup>1</sup>	Security Fuse Programmed	PRA, PRB <sup>2</sup>	TDI, TCK, TDO <sup>2</sup>
Dedicated	Low	No	User I/O <sup>3</sup>	JTAG Disabled
	High	No	Probe Circuit Outputs	JTAG I/O
Flexible	Low	No	User I/O <sup>3</sup>	User I/O <sup>3</sup>
	High	No	Probe Circuit Outputs	JTAG I/O
		Yes	Probe Circuit Secured	Probe Circuit Secured

**Notes:**

1. If the TRST pin is not reserved, the device behaves according to TRST = High as described in the table.
2. Avoid using the TDI, TCK, TDO, PRA, and PRB pins as input or bidirectional ports. Since these pins are active during probing, input signals will not pass through these pins and may cause contention.
3. If no user signal is assigned to these pins, they will behave as unused I/Os in this mode. Unused pins are automatically tristated by the Designer software.

## Design Environment

The SX-A family of FPGAs is fully supported by both Actel Libero® Integrated Design Environment (IDE) and Designer FPGA development software. Actel Libero IDE is a design management environment, seamlessly integrating design tools while guiding the user through the design flow, managing all design and log files, and passing necessary design data among tools. Additionally, Libero IDE allows users to integrate both schematic and HDL synthesis into a single flow and verify the entire design in a single environment. Libero IDE includes Synplify® for Actel from Synplicity®, ViewDraw® for Actel from Mentor Graphics®, ModelSim® HDL Simulator from Mentor Graphics, WaveFormer Lite™ from SynaptiCAD™, and Designer software from Actel. Refer to the *Libero IDE* flow diagram for more information (located on the Actel website).

Actel Designer software is a place-and-route tool and provides a comprehensive suite of backend support tools for FPGA development. The Designer software includes timing-driven place-and-route, and a world-class integrated static timing analyzer and constraints editor. With the Designer software, a user can select and lock package pins while only minimally impacting the results of place-and-route. Additionally, the back-annotation flow is compatible with all the major simulators and the simulation results can be cross-probed with Silicon Explorer II, Actel's integrated verification and logic analysis tool. Another tool included in the Designer software is the SmarGen core generator, which easily creates popular and commonly used logic functions for implementation in your schematic or HDL design. Actel's Designer software is compatible with the most popular FPGA design entry and verification tools from companies such as Mentor Graphics, Synplicity, Synopsys, and Cadence Design Systems. The Designer software is available for both the Windows and UNIX operating systems.

## Programming

Device programming is supported through Silicon Sculptor series of programmers. In particular, Silicon Sculptor is compact, robust, single-site and multi-site device programmer for the PC.

With standalone software, Silicon Sculptor allows concurrent programming of multiple units from the same PC, ensuring the fastest programming times possible. Each fuse is subsequently verified by Silicon Sculptor II to insure correct programming. In addition, integrity tests ensure that no extra fuses are programmed. Silicon Sculptor also provides extensive hardware self-testing capability.

The procedure for programming an SX-A device using Silicon Sculptor is as follows:

1. Load the .AFM file
2. Select the device to be programmed
3. Begin programming

When the design is ready to go to production, Actel offers device volume-programming services either through distribution partners or via in-house programming from the factory.

For detailed information on programming, read the following documents *Programming Antifuse Devices* and *Silicon Sculptor User's Guide*.

To determine the heat sink's thermal performance, use the following equation:

$$\theta_{JA(TOTAL)} = \theta_{JC} + \theta_{CS} + \theta_{SA}$$

EQ 2-14

where:

$$\theta_{CS} = 0.37^{\circ}\text{C}/\text{W}$$

= thermal resistance of the interface material between the case and the heat sink, usually provided by the thermal interface manufacturer

$$\theta_{SA} = \text{thermal resistance of the heat sink in } ^{\circ}\text{C}/\text{W}$$

$$\theta_{SA} = \theta_{JA(TOTAL)} - \theta_{JC} - \theta_{CS}$$

EQ 2-15

$$\theta_{SA} = 13.33^{\circ}\text{C}/\text{W} - 3.20^{\circ}\text{C}/\text{W} - 0.37^{\circ}\text{C}/\text{W}$$

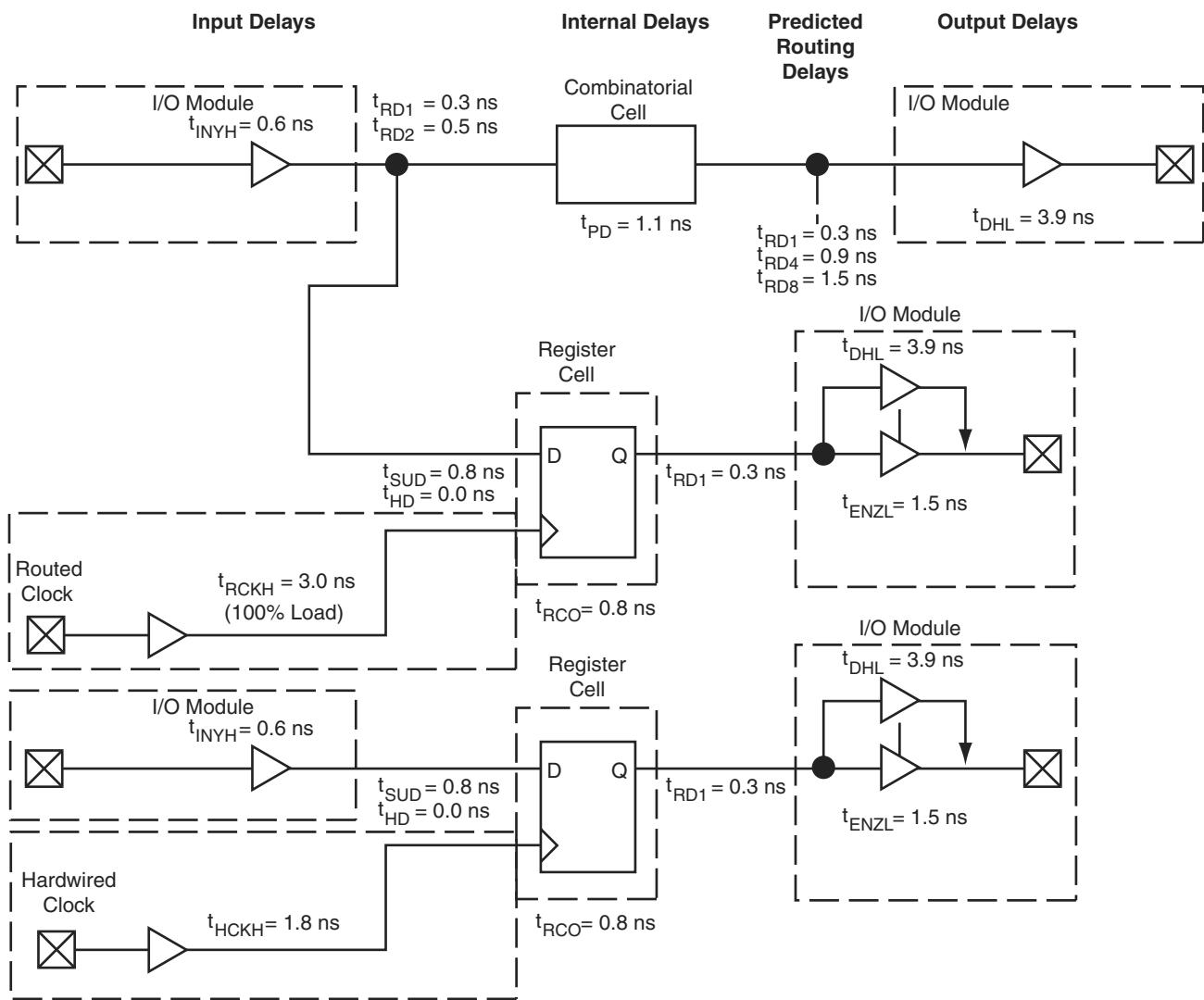
$$\theta_{SA} = 9.76^{\circ}\text{C}/\text{W}$$

A heat sink with a thermal resistance of  $9.76^{\circ}\text{C}/\text{W}$  or better should be used. Thermal resistance of heat sinks is a function of airflow. The heat sink performance can be significantly improved with the presence of airflow.

Carefully estimating thermal resistance is important in the long-term reliability of an Actel FPGA. Design engineers should always correlate the power consumption of the device with the maximum allowable power dissipation of the package selected for that device, using the provided thermal resistance data.

Note: The values may vary depending on the application.

## SX-A Timing Model



**Note:** \*Values shown for A54SX72A, -2, worst-case commercial conditions at 5 V PCI with standard place-and-route.

Figure 2-3 • SX-A Timing Model

## Sample Path Calculations

### Hardwired Clock

$$\begin{aligned}
 \text{External Setup} &= (t_{INYH} + t_{RD1} + t_{SUD}) - t_{HCKH} \\
 &= 0.6 + 0.3 + 0.8 - 1.8 = -0.1 \text{ ns} \\
 \text{Clock-to-Out (Pad-to-Pad)} &= t_{HCKH} + t_{RCO} + t_{RD1} + t_{DHL} \\
 &= 1.8 + 0.8 + 0.3 + 3.9 = 6.8 \text{ ns}
 \end{aligned}$$

### Routed Clock

$$\begin{aligned}
 \text{External Setup} &= (t_{INYH} + t_{RD1} + t_{SUD}) - t_{RCKH} \\
 &= 0.6 + 0.3 + 0.8 - 3.0 = -1.3 \text{ ns} \\
 \text{Clock-to-Out (Pad-to-Pad)} &= t_{RCKH} + t_{RCO} + t_{RD1} + t_{DHL} \\
 &= 3.0 + 0.8 + 0.3 + 3.9 = 8.0 \text{ ns}
 \end{aligned}$$

## Output Buffer Delays

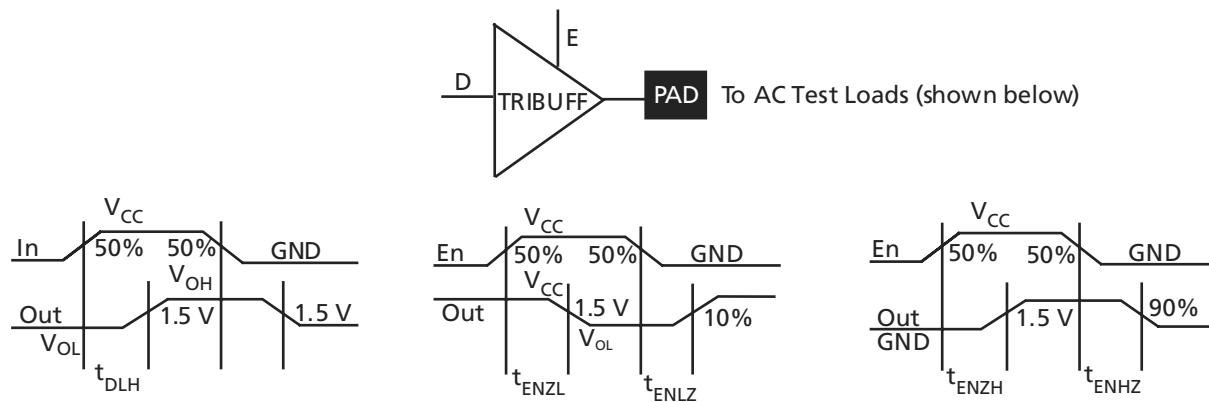


Figure 2-4 • Output Buffer Delays

## AC Test Loads

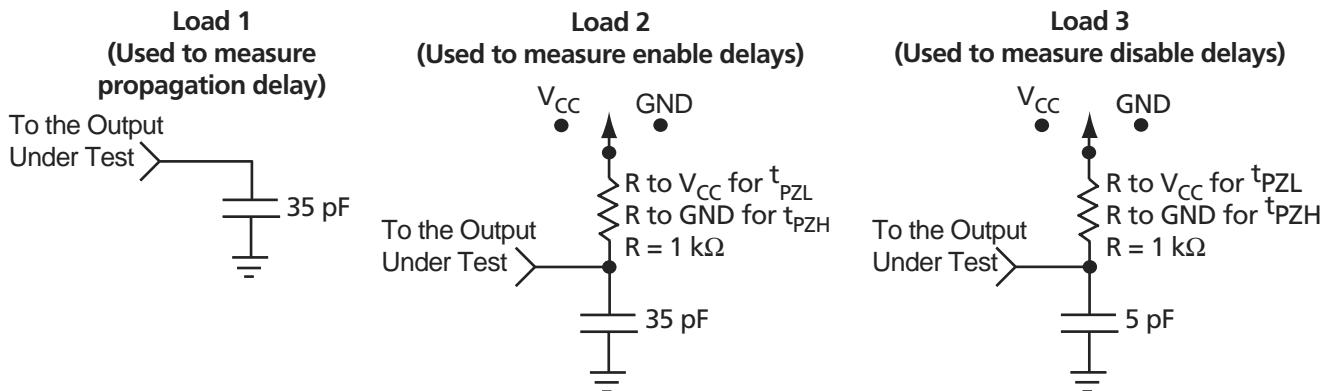


Figure 2-5 • AC Test Loads

Table 2-16 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>		<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>									
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)		1.3		1.5		1.7		2.6 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.1		1.3		1.5		2.2 ns
$t_{HPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9	ns
$t_{HCKSW}$	Maximum Skew		0.4		0.5		0.5		0.8 ns
$t_{HP}$	Minimum Period	3.2		3.6		4.2		5.8	ns
$f_{HMAX}$	Maximum Frequency		313		278		238		172 MHz
<b>Routed Array Clock Networks</b>									
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		0.8		0.9		1.1		1.5 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.1		1.2		1.4		2 ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		0.8		0.9		1.1		1.5 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		1.1		1.2		1.4		2 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		1.1		1.2		1.4		1.9 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		1.2		1.3		1.6		2.2 ns
$t_{RPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)		0.7		0.8		0.9		1.3 ns
$t_{RCKSW}$	Maximum Skew (50% Load)		0.7		0.8		0.9		1.3 ns
$t_{RCKSW}$	Maximum Skew (100% Load)		0.8		0.9		1.1		1.5 ns

Table 2-30 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.7	2.0	2.2	2.6	4.0	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{HCKSW}$	Maximum Skew	0.6	0.6	0.7	0.8	1.3	ns
$t_{HP}$	Minimum Period	2.8	3.2	3.6	4.2	5.8	ns
$f_{HMAX}$	Maximum Frequency	357	313	278	238	172	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2	2.5	2.8	3.3	4.6	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.1	2.4	2.7	3.2	4.5	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.3	2.7	3.1	3.6	5	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.2	2.5	2.9	3.4	4.7	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.4	2.8	3.2	3.7	5.2	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	2.4	2.8	3.1	3.7	5.1	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.6	1.8	2.1	2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.6	1.8	2.1	2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.0	1.1	1.3	1.5	2.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.9	1.0	1.2	1.4	1.9	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	0.9	1.0	1.2	1.4	1.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-32 • A54SX32A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.3\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	<b>Min. Max.</b>	
<b>2.5 V LVC MOS Output Module Timing<sup>2,3</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.3	3.8	4.2	5.0	7.0	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.2	3.8	5.3	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	11.1	12.8	14.5	17.0	23.8	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.4	2.8	3.2	3.7	5.2	ns
$t_{ENZLS}$	Data-to-Pad, Z to L—low slew	11.8	13.7	15.5	18.2	25.5	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.3	3.8	4.2	5.0	7.0	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.1	2.5	2.8	3.3	4.7	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.2	3.8	5.3	ns
$d_{TLH}^4$	Delta Low to High	0.031	0.037	0.043	0.051	0.071	ns/pF
$d_{THL}^4$	Delta High to Low	0.017	0.017	0.023	0.023	0.037	ns/pF
$d_{THLS}^4$	Delta High to Low—low slew	0.057	0.06	0.071	0.086	0.117	ns/pF

**Note:**

1. All -3 speed grades have been discontinued.
2. Delays based on 35 pF loading.
3. The equivalent IO Attribute settings for 2.5 V LVC MOS is 2.5 V LVTTL in the software.
4. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.

Table 2-35 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions,  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>	
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>		
<b>C-Cell Propagation Delays<sup>2</sup></b>											
$t_{PD}$	Internal Array Module	1.0		1.1		1.3		1.5		2.0	ns
<b>Predicted Routing Delays<sup>3</sup></b>											
$t_{DC}$	FO = 1 Routing Delay, Direct Connect	0.1		0.1		0.1		0.1		ns	
$t_{FC}$	FO = 1 Routing Delay, Fast Connect	0.3		0.3		0.3		0.4		0.6	ns
$t_{RD1}$	FO = 1 Routing Delay	0.3		0.3		0.4		0.5		0.7	ns
$t_{RD2}$	FO = 2 Routing Delay	0.4		0.5		0.6		0.7		1	ns
$t_{RD3}$	FO = 3 Routing Delay	0.5		0.7		0.8		0.9		1.3	ns
$t_{RD4}$	FO = 4 Routing Delay	0.7		0.9		1		1.1		1.5	ns
$t_{RD8}$	FO = 8 Routing Delay	1.2		1.5		1.7		2.1		2.9	ns
$t_{RD12}$	FO = 12 Routing Delay	1.7		2.2		2.5		3		4.2	ns
<b>R-Cell Timing</b>											
$t_{RCO}$	Sequential Clock-to-Q	0.7		0.8		0.9		1.1		1.5	ns
$t_{CLR}$	Asynchronous Clear-to-Q	0.6		0.7		0.7		0.9		1.2	ns
$t_{PRESET}$	Asynchronous Preset-to-Q	0.7		0.8		0.8		1.0		1.4	ns
$t_{SUD}$	Flip-Flop Data Input Set-Up	0.7		0.8		0.9		1.0		1.4	ns
$t_{HD}$	Flip-Flop Data Input Hold	0.0		0.0		0.0		0.0		0.0	ns
$t_{WASYN}$	Asynchronous Pulse Width	1.3		1.5		1.7		2.0		2.8	ns
$t_{RECASYN}$	Asynchronous Recovery Time	0.3		0.4		0.4		0.5		0.7	ns
$t_{HASYN}$	Asynchronous Hold Time	0.3		0.3		0.3		0.4		0.6	ns
$t_{MPW}$	Clock Minimum Pulse Width	1.5		1.7		2.0		2.3		3.2	ns
<b>Input Module Propagation Delays</b>											
$t_{INYH}$	Input Data Pad to Y High 2.5 V LVC MOS	0.6		0.7		0.8		0.9		1.3	ns
$t_{INYL}$	Input Data Pad to Y Low 2.5 V LVC MOS	0.8		1.0		1.1		1.3		1.7	ns
$t_{INYH}$	Input Data Pad to Y High 3.3 V PCI	0.6		0.7		0.7		0.9		1.2	ns
$t_{INYL}$	Input Data Pad to Y Low 3.3 V PCI	0.7		0.8		0.9		1.0		1.4	ns
$t_{INYH}$	Input Data Pad to Y High 3.3 V LV TTL	0.7		0.7		0.8		1.0		1.4	ns
$t_{INYL}$	Input Data Pad to Y Low 3.3 V LV TTL	1.0		1.2		1.3		1.5		2.1	ns

**Notes:**

1. All -3 speed grades have been discontinued.
2. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
3. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.

Table 2-37 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>										
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6		1.9		2.1		2.5		3.8 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.7		1.9		2.1		2.5	3.8 ns
$t_{HPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2 ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2 ns
$t_{HCKSW}$	Maximum Skew		1.4		1.6		1.8		2.1	3.3 ns
$t_{HP}$	Minimum Period	3.0		3.4		4.0		4.6		6.4 ns
$f_{HMAX}$	Maximum Frequency		333		294		250		217	156 MHz
<b>Routed Array Clock Networks</b>										
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2		2.6		2.9		3.4		4.8 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		2.8		3.3		3.7		4.3	6.0 ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.4		2.8		3.2		3.7		5.2 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		2.9		3.4		3.8		4.5	6.2 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6		3.0		3.4		4.0		5.6 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		3.1		3.6		4.1		4.8	6.7 ns
$t_{RPWH}$	Minimum Pulse Width High	1.5		1.7		2.0		2.3		3.2 ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5		1.7		2.0		2.3		3.2 ns
$t_{RCKSW}$	Maximum Skew (Light Load)		1.9		2.2		2.5		3	4.1 ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.9		2.1		2.4		2.8		3.9 ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.9		2.1		2.4		2.8		3.9 ns
<b>Quadrant Array Clock Networks</b>										
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.3		1.5		1.7		1.9		2.7 ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.3		1.5		1.7		2	2.8 ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.5		1.7		1.9		2.2		3.1 ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.5		1.8		2		2.3		3.2 ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-38 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6	1.8	2.1	2.4	3.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.8	ns
$t_{HPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{HCKSW}$	Maximum Skew	1.4	1.6	1.8	2.1	3.3	ns
$t_{HP}$	Minimum Period	3.0	3.4	4.0	4.6	6.4	ns
$f_{HMAX}$	Maximum Frequency	333	294	250	217	156	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.3	2.6	3.0	3.5	4.9	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.8	3.2	3.6	4.3	6.0	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.5	2.9	3.2	3.8	5.3	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	3.0	3.4	3.9	4.6	6.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6	3.0	3.4	3.9	5.5	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	3.2	3.6	4.1	4.8	6.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.9	2.2	2.5	3.0	4.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.9	2.2	2.5	3.0	4.1	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.9	2.2	2.5	3.0	4.1	ns
<b>Quadrant Array Clock Networks</b>							
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.6	ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.3	1.4	1.6	1.9	2.7	ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.4	1.6	1.8	2.1	3.0	ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.4	1.7	1.9	2.2	3.1	ns

**Note:** \*All -3 speed grades have been discontinued.

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
1	GND	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O	I/O
4	NC	I/O	I/O	I/O
5	I/O	I/O	I/O	I/O
6	NC	I/O	I/O	I/O
7	I/O	I/O	I/O	I/O
8	I/O	I/O	I/O	I/O
9	I/O	I/O	I/O	I/O
10	I/O	I/O	I/O	I/O
11	TMS	TMS	TMS	TMS
12	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
13	I/O	I/O	I/O	I/O
14	NC	I/O	I/O	I/O
15	I/O	I/O	I/O	I/O
16	I/O	I/O	I/O	I/O
17	NC	I/O	I/O	I/O
18	I/O	I/O	I/O	GND
19	I/O	I/O	I/O	V <sub>CCA</sub>
20	NC	I/O	I/O	I/O
21	I/O	I/O	I/O	I/O
22	I/O	I/O	I/O	I/O
23	NC	I/O	I/O	I/O
24	I/O	I/O	I/O	I/O
25	NC	NC	NC	I/O
26	GND	GND	GND	GND
27	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
28	GND	GND	GND	GND
29	I/O	I/O	I/O	I/O
30	TRST, I/O	TRST, I/O	TRST, I/O	TRST, I/O
31	NC	I/O	I/O	I/O
32	I/O	I/O	I/O	I/O
33	I/O	I/O	I/O	I/O
34	I/O	I/O	I/O	I/O
35	NC	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
36	I/O	I/O	I/O	I/O
37	I/O	I/O	I/O	I/O
38	I/O	I/O	I/O	I/O
39	NC	I/O	I/O	I/O
40	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
41	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
42	I/O	I/O	I/O	I/O
43	I/O	I/O	I/O	I/O
44	I/O	I/O	I/O	I/O
45	I/O	I/O	I/O	I/O
46	I/O	I/O	I/O	I/O
47	I/O	I/O	I/O	I/O
48	NC	I/O	I/O	I/O
49	I/O	I/O	I/O	I/O
50	NC	I/O	I/O	I/O
51	I/O	I/O	I/O	I/O
52	GND	GND	GND	GND
53	I/O	I/O	I/O	I/O
54	I/O	I/O	I/O	I/O
55	I/O	I/O	I/O	I/O
56	I/O	I/O	I/O	I/O
57	I/O	I/O	I/O	I/O
58	I/O	I/O	I/O	I/O
59	I/O	I/O	I/O	I/O
60	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
61	NC	I/O	I/O	I/O
62	I/O	I/O	I/O	I/O
63	I/O	I/O	I/O	I/O
64	NC	I/O	I/O	I/O
65	I/O	I/O	NC	I/O
66	I/O	I/O	I/O	I/O
67	NC	I/O	I/O	I/O
68	I/O	I/O	I/O	I/O
69	I/O	I/O	I/O	I/O
70	NC	I/O	I/O	I/O

<b>100-TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
1	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O
4	I/O	I/O	I/O
5	I/O	I/O	I/O
6	I/O	I/O	I/O
7	TMS	TMS	TMS
8	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
9	GND	GND	GND
10	I/O	I/O	I/O
11	I/O	I/O	I/O
12	I/O	I/O	I/O
13	I/O	I/O	I/O
14	I/O	I/O	I/O
15	I/O	I/O	I/O
16	TRST, I/O	TRST, I/O	TRST, I/O
17	I/O	I/O	I/O
18	I/O	I/O	I/O
19	I/O	I/O	I/O
20	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
21	I/O	I/O	I/O
22	I/O	I/O	I/O
23	I/O	I/O	I/O
24	I/O	I/O	I/O
25	I/O	I/O	I/O
26	I/O	I/O	I/O
27	I/O	I/O	I/O
28	I/O	I/O	I/O
29	I/O	I/O	I/O
30	I/O	I/O	I/O
31	I/O	I/O	I/O
32	I/O	I/O	I/O
33	I/O	I/O	I/O
34	PRB, I/O	PRB, I/O	PRB, I/O
35	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>

<b>100-TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
36	GND	GND	GND
37	NC	NC	NC
38	I/O	I/O	I/O
39	HCLK	HCLK	HCLK
40	I/O	I/O	I/O
41	I/O	I/O	I/O
42	I/O	I/O	I/O
43	I/O	I/O	I/O
44	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
45	I/O	I/O	I/O
46	I/O	I/O	I/O
47	I/O	I/O	I/O
48	I/O	I/O	I/O
49	TDO, I/O	TDO, I/O	TDO, I/O
50	I/O	I/O	I/O
51	GND	GND	GND
52	I/O	I/O	I/O
53	I/O	I/O	I/O
54	I/O	I/O	I/O
55	I/O	I/O	I/O
56	I/O	I/O	I/O
57	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
58	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
59	I/O	I/O	I/O
60	I/O	I/O	I/O
61	I/O	I/O	I/O
62	I/O	I/O	I/O
63	I/O	I/O	I/O
64	I/O	I/O	I/O
65	I/O	I/O	I/O
66	I/O	I/O	I/O
67	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
68	GND	GND	GND
69	GND	GND	GND
70	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
1	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O
4	I/O	I/O	I/O
5	I/O	I/O	I/O
6	I/O	I/O	I/O
7	I/O	I/O	I/O
8	I/O	I/O	I/O
9	TMS	TMS	TMS
10	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
11	GND	GND	GND
12	I/O	I/O	I/O
13	I/O	I/O	I/O
14	I/O	I/O	I/O
15	I/O	I/O	I/O
16	I/O	I/O	I/O
17	I/O	I/O	I/O
18	I/O	I/O	I/O
19	NC	NC	NC
20	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
21	I/O	I/O	I/O
22	TRST, I/O	TRST, I/O	TRST, I/O
23	I/O	I/O	I/O
24	I/O	I/O	I/O
25	I/O	I/O	I/O
26	I/O	I/O	I/O
27	I/O	I/O	I/O
28	GND	GND	GND
29	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
30	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
31	I/O	I/O	I/O
32	I/O	I/O	I/O
33	I/O	I/O	I/O
34	I/O	I/O	I/O
35	I/O	I/O	I/O
36	GND	GND	GND
37	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
38	I/O	I/O	I/O
39	I/O	I/O	I/O
40	I/O	I/O	I/O
41	I/O	I/O	I/O
42	I/O	I/O	I/O
43	I/O	I/O	I/O
44	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
45	I/O	I/O	I/O
46	I/O	I/O	I/O
47	I/O	I/O	I/O
48	I/O	I/O	I/O
49	I/O	I/O	I/O
50	I/O	I/O	I/O
51	I/O	I/O	I/O
52	I/O	I/O	I/O
53	I/O	I/O	I/O
54	PRB, I/O	PRB, I/O	PRB, I/O
55	I/O	I/O	I/O
56	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
57	GND	GND	GND
58	NC	NC	NC
59	I/O	I/O	I/O
60	HCLK	HCLK	HCLK
61	I/O	I/O	I/O
62	I/O	I/O	I/O
63	I/O	I/O	I/O
64	I/O	I/O	I/O
65	I/O	I/O	I/O
66	I/O	I/O	I/O
67	I/O	I/O	I/O
68	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
69	I/O	I/O	I/O
70	I/O	I/O	I/O
71	TDO, I/O	TDO, I/O	TDO, I/O
72	I/O	I/O	I/O
73	GND	GND	GND
74	I/O	I/O	I/O

## 176-Pin TQFP

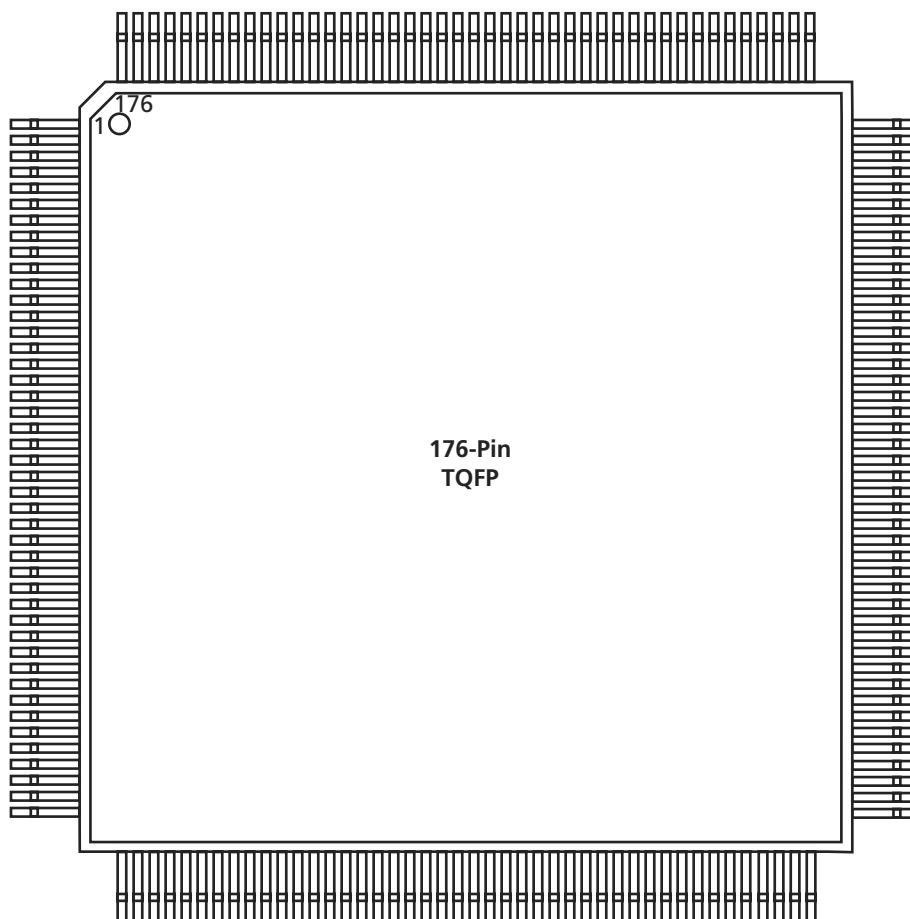


Figure 3-4 • 176-Pin TQFP (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
C19	I/O	I/O
C20	V <sub>CCI</sub>	V <sub>CCI</sub>
C21	I/O	I/O
C22	I/O	I/O
C23	I/O	I/O
C24	I/O	I/O
C25	NC*	I/O
C26	NC*	I/O
D1	NC*	I/O
D2	TMS	TMS
D3	I/O	I/O
D4	V <sub>CCI</sub>	V <sub>CCI</sub>
D5	NC*	I/O
D6	TCK, I/O	TCK, I/O
D7	I/O	I/O
D8	I/O	I/O
D9	I/O	I/O
D10	I/O	I/O
D11	I/O	I/O
D12	I/O	QCLKC
D13	I/O	I/O
D14	I/O	I/O
D15	I/O	I/O
D16	I/O	I/O
D17	I/O	I/O
D18	I/O	I/O
D19	I/O	I/O
D20	I/O	I/O
D21	V <sub>CCI</sub>	V <sub>CCI</sub>
D22	GND	GND
D23	I/O	I/O
D24	I/O	I/O
D25	NC*	I/O
D26	NC*	I/O
E1	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
E2	NC*	I/O
E3	I/O	I/O
E4	I/O	I/O
E5	GND	GND
E6	TDI, IO	TDI, IO
E7	I/O	I/O
E8	I/O	I/O
E9	I/O	I/O
E10	I/O	I/O
E11	I/O	I/O
E12	I/O	I/O
E13	V <sub>CCA</sub>	V <sub>CCA</sub>
E14	CLKB	CLKB
E15	I/O	I/O
E16	I/O	I/O
E17	I/O	I/O
E18	I/O	I/O
E19	I/O	I/O
E20	I/O	I/O
E21	I/O	I/O
E22	I/O	I/O
E23	I/O	I/O
E24	I/O	I/O
E25	V <sub>CCI</sub>	V <sub>CCI</sub>
E26	GND	GND
F1	V <sub>CCI</sub>	V <sub>CCI</sub>
F2	NC*	I/O
F3	NC*	I/O
F4	I/O	I/O
F5	I/O	I/O
F22	I/O	I/O
F23	I/O	I/O
F24	I/O	I/O
F25	I/O	I/O
F26	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
G1	NC*	I/O
G2	NC*	I/O
G3	NC*	I/O
G4	I/O	I/O
G5	I/O	I/O
G22	I/O	I/O
G23	V <sub>CCA</sub>	V <sub>CCA</sub>
G24	I/O	I/O
G25	NC*	I/O
G26	NC*	I/O
H1	NC*	I/O
H2	NC*	I/O
H3	I/O	I/O
H4	I/O	I/O
H5	I/O	I/O
H22	I/O	I/O
H23	I/O	I/O
H24	I/O	I/O
H25	NC*	I/O
H26	NC*	I/O
J1	NC*	I/O
J2	NC*	I/O
J3	I/O	I/O
J4	I/O	I/O
J5	I/O	I/O
J22	I/O	I/O
J23	I/O	I/O
J24	I/O	I/O
J25	V <sub>CCI</sub>	V <sub>CCI</sub>
J26	NC*	I/O
K1	I/O	I/O
K2	V <sub>CCI</sub>	V <sub>CCI</sub>
K3	I/O	I/O
K4	I/O	I/O
K5	V <sub>CCA</sub>	V <sub>CCA</sub>

**Note:** \*These pins must be left floating on the A54SX32A device.

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